

EVVOSEMI[®]

THINK CHANGE DO



ESD



TVS



MOS



LDO



Diode



Sensor



DC-DC

Product Specification

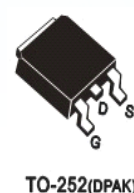
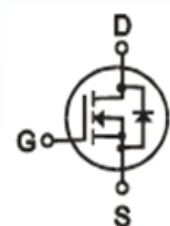
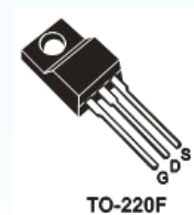
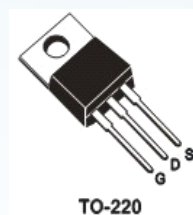
▶ Domestic	Part Number	4N65
▶ Overseas	Part Number	4N65
▶ Equivalent	Part Number	4N65

EV is the abbreviation of name EVVO

N-沟道功率 MOS 管

Features

- $V_{DS}(V)=650V$
- $I_D=4.0A$
- $R_{DS(ON)} \leq 2.7 \Omega$ ($V_{GS} = 10V$)

●最大额定值 ($T_c=25^\circ C$)●Absolute Maximum Ratings ($T_c=25^\circ C$) TO-220/220F/TO-252

参数 PARAMETER	符号 SYMBOL	额定值 VALUE	单位 UNIT
- 漏源电压 Drain-source Voltage	V_{DS}	650	V
- 栅源电压 gate-source Voltage	V_{GS}	$30 \pm$	V
漏极电流 Continuous Drain Current $T_C=25^\circ C$	I_D	4.0	A
漏极电流 Continuous Drain Current $T_C=100^\circ C$	I_D	2.5	A
最大脉冲电流 Drain Current — Pulsed ①	I_{DM}	16	A
耗散功率 Power Dissipation	P_{tot}	TO-220:100	W
		TO-220F:33	
最高结温 Junction Temperature	T_j	150	$^\circ C$
存储温度 Storage Temperature	T_{STG}	-55-150	$^\circ C$
单脉冲雪崩能量 Single Pulse Avalanche Energy ②	E_{AS}	128	mJ

N-沟道功率 MOS 管

- 电特性 (Tc=25 C)
- Electronic Characteristics (Tc=25°C)

参数 PARAMETER	符号 SYMBOL	测试条件 TEST CONDITION	最小值 MIN	典型值 TYP	最大值 MAX	单位 UNIT
- 漏 源击穿电压 Drain-source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	650			V
击穿电压温度系数 Breakdown Voltage Temperature Coefficient	BVΔ _{DSS/ΔTj}	I _D =250uA, Referenced to 25°C		0.6		V/°C
栅极开启电压 Gate Threshold Voltage	V _{GS(TH)}	V _{GS} =V _{DS} , I _D =250μA	2.0		4.0	V
源漏电流 Drain-source Leakage Current	I _{DSS}	V _{DS} =650V, V _{GS} =0V, Tj=25°C			25	μA
		V _{DS} =520V, V _{GS} =0V, Tj=125°C			250	μA
跨导 Forward Transconductance	gfs	V _{DS} =40V, I _D =2.0A ③		2.5		S

N-沟道功率 MOS 管

参数 PARAMETER	符号 SYMBOL	测试条件 TEST CONDITION	最小值 MIN	典型值 TYP	最大值 MAX	单位 UNIT
栅极漏电流 Gate-body Leakage Current ($V_{DS} = 0$)	I_{GSS}	$V_{GS} = \pm 30V$			± 100	nA
- 漏源导通电阻 Static Drain-source On Resistance	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 2.0A$ ③		2.3	2.7	Ω
输入电容 Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 25V$ $F = 1.0MHz$		500		pF
关断延迟 Turn -Off Delay Time	$T_d(off)$	$V_{DD} = 325V, I_D = 4.0A$ $R_G = 25\Omega$ ③		40		ns
栅极电荷 Total Gate Charge	Q_g	$I_D = 4.0A, V_{DS} = 520V$ $V_{GS} = 10V$ ③		15.8		nC
栅源电荷 Gate-to-Source Charge	Q_{gs}			3.5		nC
栅漏电荷 Gate-to-Drain Charge	Q_{gd}			6.0		nC
二极管正向电流 Continuous Diode Forward Current	I_S				4.0	A
二极管正向压降 Diode Forward Voltage	V_{SD}	$T_j = 25^\circ C, I_S = 4.0A$ $V_{GS} = 0V$ ③			1.4	V
反向恢复时间 Reverse Recovery Time	t_{rr}	$T_j = 25^\circ C, I_f = 4.0A$ $di/dt = 100A/\mu s$ ③		390		ns
反向恢复电荷 Reverse Recovery Charge	Q_{rr}			1.5		μC

●热特性

●Thermal Characteristics

参数 PARAMETER	符号 SYMBOL	最大值 MAX			单位 UNIT
		TO-220	TO-220F		
热阻结-壳 Thermal Resistance Junction-case	R_{thJC}	1.25	3.79		/WC
- 热阻结 环境 Thermal Resistance Junction-ambient	R_{thJA}	62.5	62.5		/WC

注释(Notes):

① 脉冲宽度：以最高结温为限制

Repetitive rating: Pulse width limited by maximum junction temperature

② 初始结温=25°C, $V_{DD} = 50V$, $L = 25mH$, $R_G = 25\Omega$, $I_{AS} = 4.0A$ Starting $T_j = 25^\circ C$, $V_{DD} = 50V$, $L = 25mH$, $R_G = 25\Omega$, $I_{AS} = 4.0A$ ③ 脉冲测试：脉冲宽度 $\leq 300\mu s$ ，占空比 $\leq 2\%$ Pulse Test : Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$

N-沟道功率 MOS 管

● 特性曲线

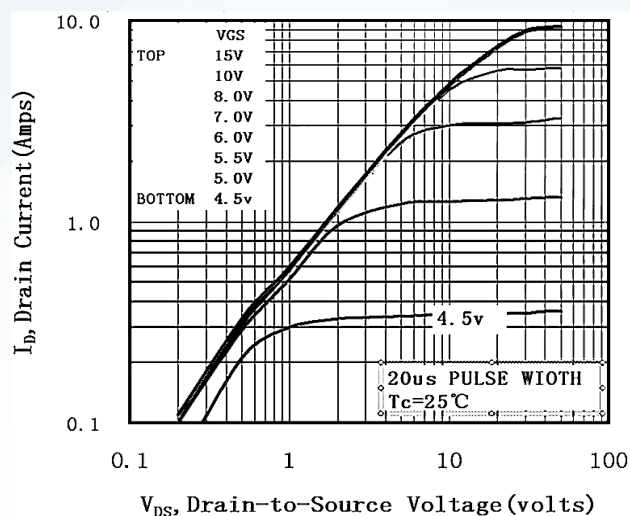
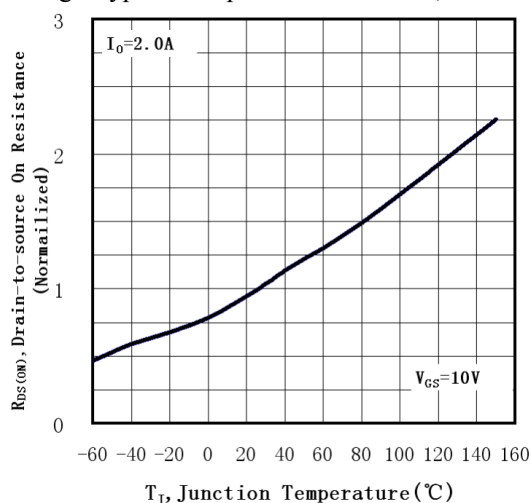
图 1 输出特性曲线, $T_c = 25^\circ\text{C}$ Fig1 Typical Output Characteristics, $T_c = 25^\circ\text{C}$ 

图 3 导通电阻与温度曲线

Fig3 Normalized On-Resistance Vs. Temperature

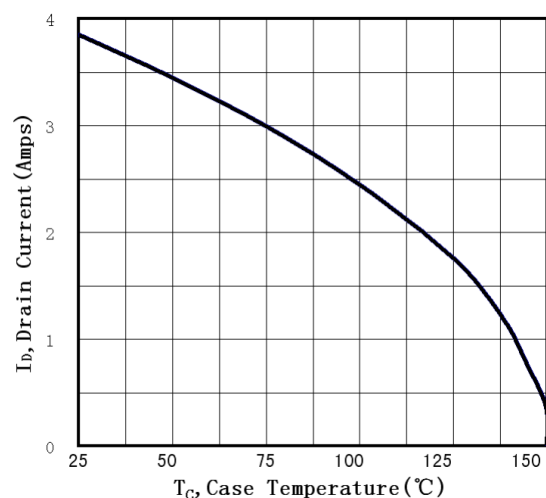


图 5 最大漏极电流与壳温曲线

Fig5 Maximum Drain Current Vs. Case Temperature

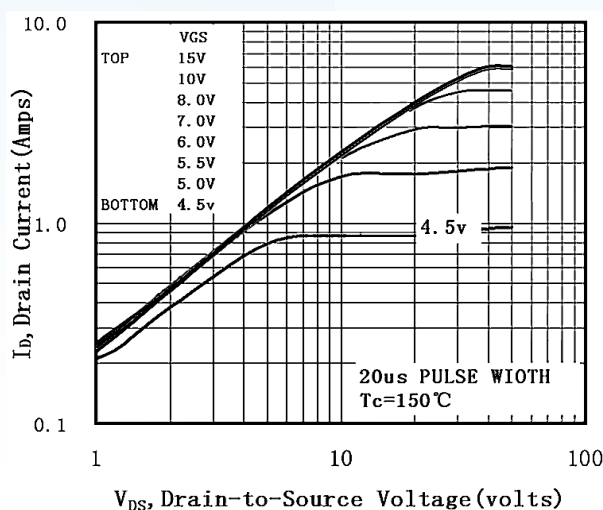
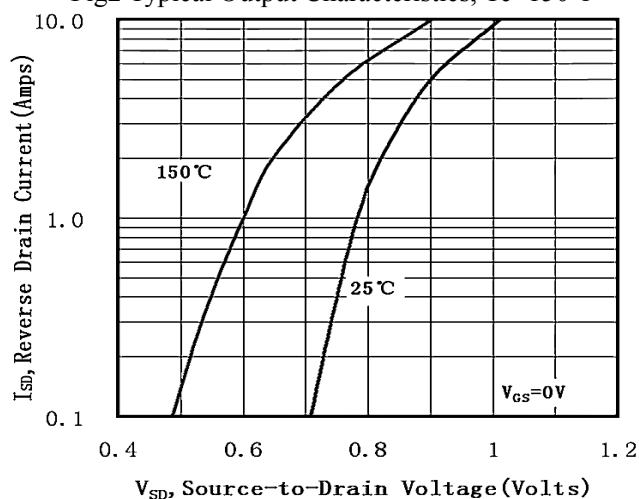
图 2 输出特性曲线, $T_c = 150^\circ\text{C}$ Fig2 Typical Output Characteristics, $T_c = 150^\circ\text{C}$ 

图 4 二极管正向电压曲线

Fig4 Typical Source-Drain Diode Forward Voltage

N-沟道功率 MOS 管

● 特性曲线

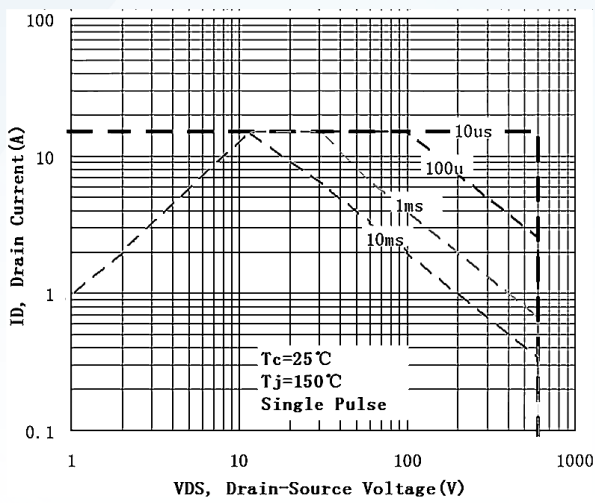


图 6-1 4N65(TO-220)
最大安全工作区曲线
Fig6-1 Maximum Safe Operating Area

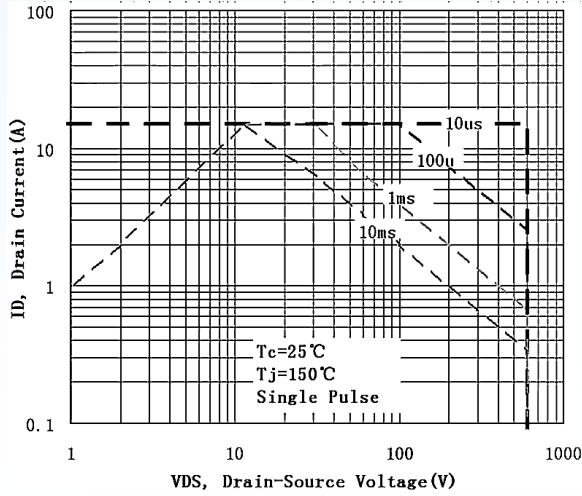


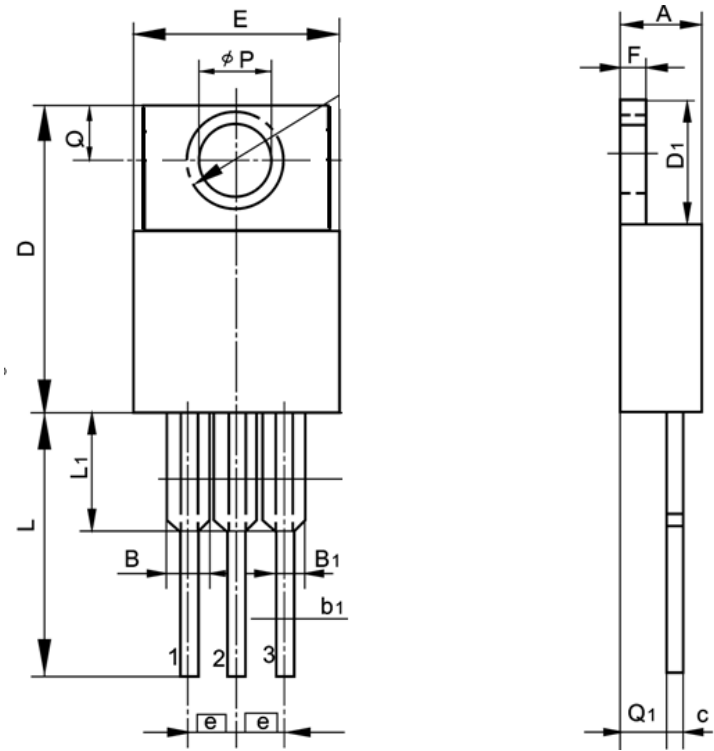
图 6-2 4N65(TO-220F)
最大安全工作区曲线
Fig6-2 Maximum Safe Operating Area

N-沟道功率 MOS 管

TO-220 封装

单位：毫米/UNIT：mm

符号 SYMBOL	最小值 min	典型值 nom	最大值 max	符号 SYMBOL	最小值 min	典型值 nom	最大值 max
A	4.00		4.80	E	9.90		10.70
B	1.20		1.50	e		2.54	
B1	1.00		1.40	F	1.10		1.45
b1	0.65		1.00	L	12.50		14.50
c	0.35		0.75	L1	3.00	3.50	4.00
D	15.00		16.50	Q	2.50		3.00
D1	5.90		6.90	Q1	2.00		3.00
				φ P	3.60		3.90

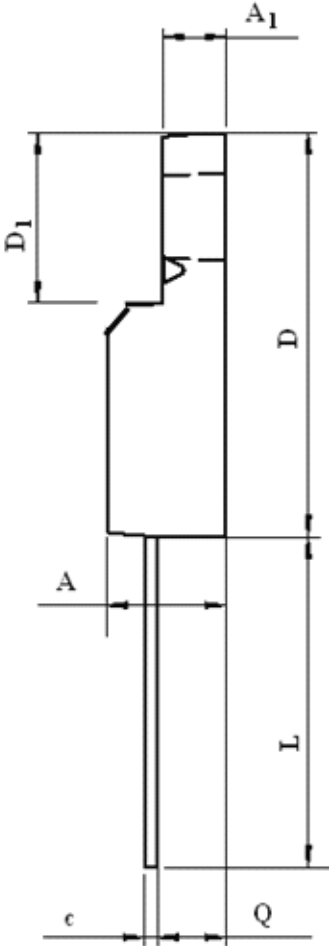
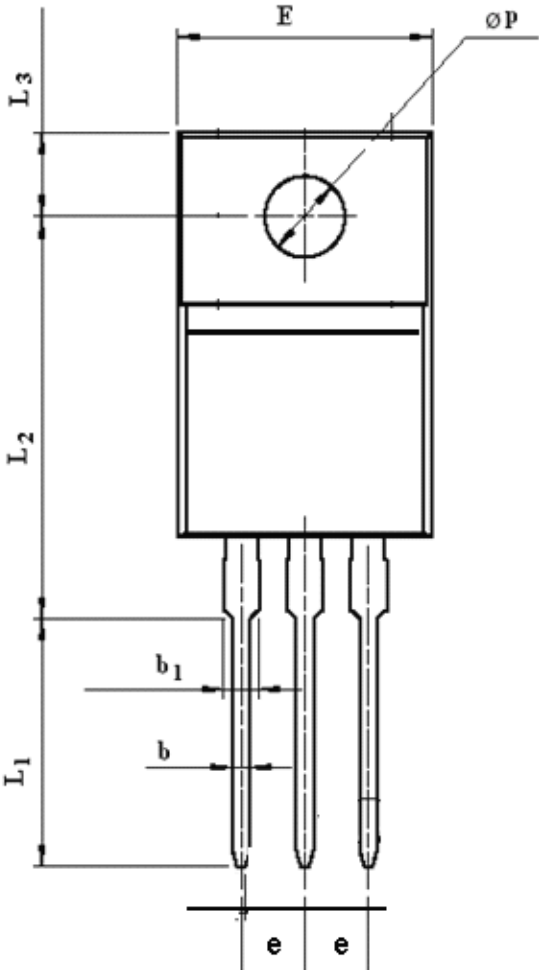


N-沟道功率 MOS 管

TO-220F 封装

单位:毫米/UNIT: mm

符号 SYMBOL	最小值 min	典型值 nom	最大值 max	符号 SYMBOL	最小值 min	典型值 nom	最大值 max
A	4.40		4.95	e		2.54	
A ₁	2.30		2.90	L	12.50		14.30
b	0.45		0.90	L ₁	9.10		10.05
b ₁	1.10		1.70	L ₂	15.00		16.00
c	0.35		0.90	L ₃	3.00		4.00
D	14.50		17.00	øp	3.00		3.50
D1	6.10		9.00	Q	2.30		2.80
E	9.60		10.30				

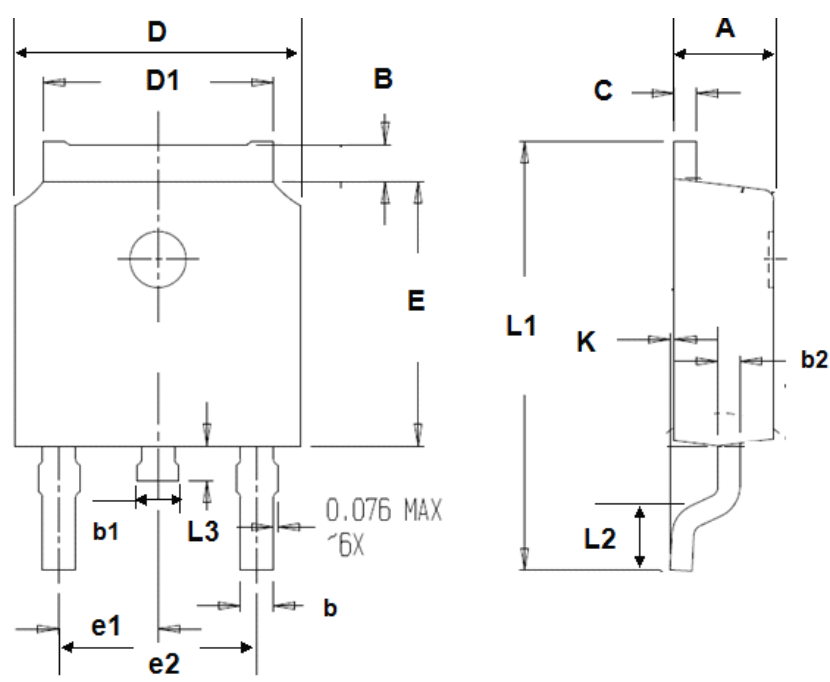


N-沟道功率 MOS 管

TO-252 封装机械尺寸
TO-252 MECHANICAL DATA

单位:毫米/UNIT: mm

符号 SYMBOL	最小值 min	最大值 max	符号 SYMBOL	最小值 min	最大值 max
A	2.10	2.50	B	0.85	1.25
b	0.50	0.80	b1	0.50	0.90
b2	0.45	0.70	C	0.45	0.70
D	6.30	6.75	D1	5.10	5.50
E	5.30	6.30	e1	2.25	2.35
L1	9.20	10.60	e2	4.45	4.75
L2	0.90	1.75	L3	0.60	1.10
K	0.00	0.23			



N-沟道功率 MOS 管

Ordering information

Order code	Package	Baseqty	Deliverymode
4N65L	TO-252	2500	Tape and reel
4N65	TO-220	1000	Tube and box
4N65F	TO-220F	1000	Tube and box

Disclaimer

EVVOSEMI ("EVVO") reserves the right to make corrections, enhancements, improvements, and other changes to its products and services at any time, and to discontinue any product or service without notice.

EVVO warrants the performance of its hardware products to the specifications applicable at the time of sale in accordance with its standard warranty. Testing and other quality control techniques are used as deemed necessary by EVVO to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

Customers should obtain and confirm the latest product information and specifications before final design, purchase, or use. EVVO makes no warranty, representation, or guarantee regarding the suitability of its products for any particular purpose, nor does EVVO assume any liability for application assistance or customer product design. EVVO does not warrant or accept any liability for products that are purchased or used for any unintended or unauthorized application.

EVVO products are not authorized for use as critical components in life support devices or systems without the express written approval of EVVOSEMI.

The EVVO logo and EVVOSEMI are trademarks of EVVOSEMI or its subsidiaries in relevant jurisdictions. EVVO reserves the right to make changes without further notice to any products herein.